



Patent Application No. 10/657,505
Customer Number: 42717

TJW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Chii-Ming Wu

§ Docket No.: 24061.406
§ (TSMC2001-1247)

Serial No.: 10/657,505

§ Examiner: Kennedy, Jennifer M.

Filing Date: September 8, 2003

§ Art Unit: 2812

For: METHOD OF MANUFACTURING A CONTACT
INTERCONNECTION LAYER CONTAINING
A METAL AND NITROGEN BY ATOMIC
LAYER DEPOSITION FOR DEEP SUB-MICRON
SEMICONDUCTOR TECHNOLOGY

RESPONSE TO RESTRICTION REQUIREMENT

Mail Stop: Amendment
Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action mailed March 10, 2005, applicant hereby elects the embodiment represented by Figs. 2a-2c and Fig. 3. Applicant also elects Group A-1 ($Ti(OCH(CH_3)_2)_4$); Group B-1 (Silicon gas source); Group C-1 (MN); and Group D-1 (CMP).

Applicant's election is made with traverse on the grounds that the embodiments delineated by the examiner are not patentably distinct and therefore constitute a single invention concept.

An early action on the merits is respectfully requested.

Respectfully submitted,

Timothy F. Bliss

Timothy F. Bliss
Reg. No. 50,925

Date: 4/11/05

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CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Mail Stop: Amendment, Commissioner For Patents, PO Box 1450, Alexandria, VA 22313-1450 on the date below.

Name

Gayle Conner

Date

4/11/05